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(54) Title: LIQUID COOLING SYSTEM AND METHOD

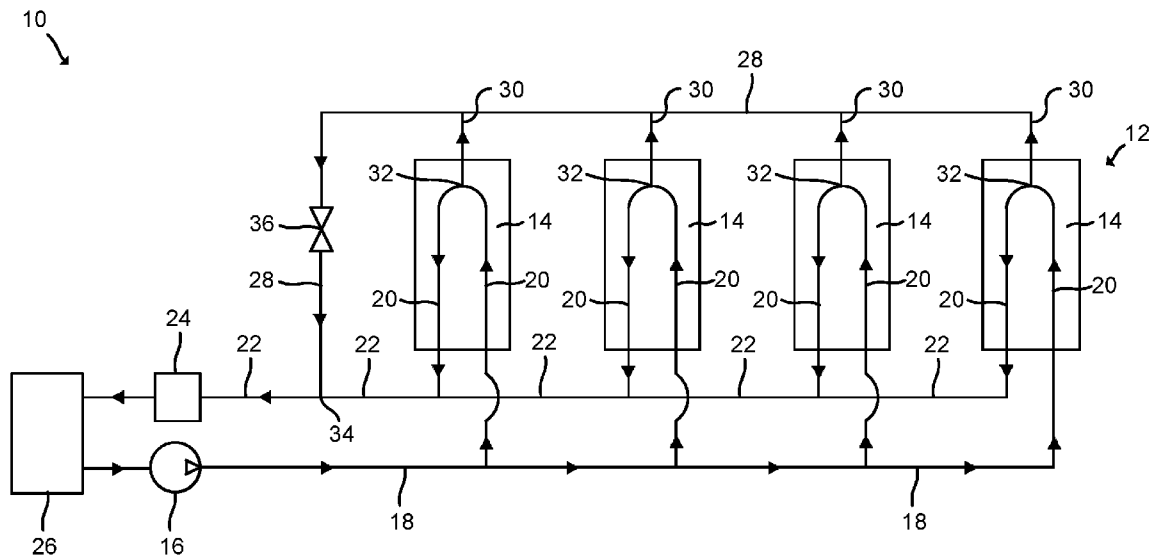


Fig. 1

(57) Abstract: Liquid cooling system (10) for cooling at least one electrical component (14), the liquid cooling system (10) comprising a cooling circuit (12) having at least one supply branch (20) for supplying liquid coolant to an electrical component (14); and at least one deaeration line (28) to provide a connection between a high point (32) and a junction point (34) of the cooling circuit (12) to bypass a part of the cooling circuit (12); wherein the pressure of the liquid coolant is lower in the junction point (34) than in the high point (32) during circulation of the liquid coolant in the liquid cooling system (10).

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## LIQUID COOLING SYSTEM AND METHOD

### Technical Field

The present disclosure generally relates to a liquid cooling system. In  
5 particular, a liquid cooling system for cooling at least one electrical  
component and a method of operating a liquid cooling system for cooling at  
least one electrical component are provided.

### Background

Various solutions exist in order to deaerate liquid coolants for liquid cooling  
10 systems by removing air and gas entrapped in the liquid medium.

US 2012090348 A1 discloses a cooling system having a closed-loop cooling  
circuit. The system comprises a coolant reservoir, a pump, fluid passages in a  
battery charging module, fluid passages in a power electronics module and a  
heat exchanger. The coolant reservoir includes a body portion defining an  
15 interior cavity configured to hold a coolant and a barrier wall positioned  
within the body portion to partition the interior cavity into an upper chamber  
and a lower chamber where the barrier wall defines an opening therethrough  
that allows fluid communication between the lower chamber and the upper  
chamber. The barrier wall prevents the air in the upper chamber from mixing  
20 with the coolant in the lower chamber.

### Summary

One object of the present disclosure is to provide a liquid cooling system  
having a simple structure and a reduced number of components.

A further object of the present disclosure is to provide a liquid cooling system  
25 that provides an effective deaeration of the liquid coolant.

A still further object of the present disclosure is to provide a liquid coolant system that can operate without danger for an operator and without leaking liquid coolant on electrical components.

According to one aspect, there is provided a liquid cooling system for cooling  
5 at least one electrical component, the liquid cooling system comprising a cooling circuit having at least one supply branch for supplying liquid coolant to an electrical component; and at least one deaeration line to provide a connection between a high point and a junction point of the cooling circuit to bypass a part of the cooling circuit; wherein the pressure of the liquid coolant  
10 is lower in the junction point than in the high point during circulation of the liquid coolant in the liquid cooling system.

In liquid cooling systems, there is a risk that air and gas entrapped in the liquid coolant accumulate in highest points of the system. For example, air may be entrapped in the liquid coolant when filling up the system. Gases may  
15 be produced by electrolysis processes or when the liquid coolant temperature is increased.

The at least one deaeration line may thus constitute, or constitute a part or section of, a deaerating path that connects one or more high points of the cooling circuit to a line where the pressure of the liquid coolant is lower, for  
20 example an outlet line or return flow line of the cooling circuit. By continuously circulating the liquid coolant in the cooling circuit, a first part of the liquid coolant can flow through the at least one supply branch to cool a respective electrical component.

At the same time, a second part of the liquid coolant flow can be divided from  
25 one or several high points of the at least one supply branch and guided through the deaeration line in order to remove the liquid coolant containing (or containing a relatively high amount of) air or gas. By deviating the second part of the liquid coolant flow through the deaeration line and recirculating this part in the liquid cooling system, the accumulation of gas and air in high  
30 points (and/or local high points) can be avoided. The second part of the

liquid coolant flow guided through the deaeration line may be 0.5-30%, such as 0.5-10%, such as 0.5-5% of the first part of the liquid coolant flow guided through the cooling circuit.

5 The liquid cooling system may further comprise a deaeration vessel arranged downstream of the junction point, e.g. upstream of a heat exchanger, in order to remove the air and gas entrapped in the liquid coolant. Alternatively, or in addition, a deaeration vessel may be arranged upstream of the junction point to cool the second liquid coolant flow.

10 Throughout the present disclosure, the cooling circuit may alternatively be referred to as a cooling medium distribution circuit and the deaeration line may alternatively be referred to as a bypass line. The language "to provide a connection" includes both variants where a line constitutes the entire connection as well as variants where the line only constitutes a part of the connection.

15 The liquid cooling system may comprise more than one deaeration line to provide a connection between a high point and a junction point of the cooling circuit. For example, two or more deaeration lines may provide a connection between one single high point of the cooling circuit and two or more separate junction points of the cooling circuit. Alternatively, two or more deaeration  
20 lines may provide a connection between two or more separate high points of the cooling circuit and one single junction point of the cooling circuit. As a further alternative, two or more deaeration lines may provide connections between two or more high points of the cooling circuit and respective two or more junction points of the cooling circuit.

25 The high point may be a high point of the at least one supply branch. It is however alternatively possible to design the cooling circuit such that the high point is positioned at other locations of the cooling circuit than in the supply branch for supplying liquid coolant to the electrical component. In case the high point is a high point of the at least one supply branch, the high point  
30 may be the highest point of the at least one supply branch. This highest point

may or may not be the highest point of the cooling circuit. In other words, this highest point may or may not be a locally highest point.

The junction point may be geodetically below the high point. Thus, the junction point may be constituted by a low point. A geodetically higher point  
5 is vertically above a geodetically lower point. The at least one supply branch may thus be arranged to elevate liquid coolant to and/or from the electrical component. Thus, at least a part of the supply branch may propagate in a direction having a vertical component. In order to elevate the liquid coolant to the high point, the liquid coolant needs to be sufficiently pressurized in a  
10 section of the supply branch upstream of the high point. Once the high point is reached by the liquid coolant, the pressure decreases as the liquid coolant flows downstream from the high point.

However, as long as the pressure of the liquid coolant is lower in the junction point than in the high point during circulation of the liquid coolant in the  
15 liquid cooling system, the junction point does not necessarily have to be geodetically below the high point. Thus, according to one variant, the junction point is geodetically above the high point.

The liquid cooling system may comprises a plurality of supply branches for supplying liquid coolant to a plurality of electrical components; and at least  
20 one deaeration line to provide a connection between each high point of the supply branches and at least one junction point of the cooling circuit; wherein the pressure of the liquid coolant is lower in the at least one junction point than in the respective high point connected to the junction point by means of the deaeration line.

25 The at least one junction point may be geodetically below the respective high point connected to the junction point by means of the deaeration line. Each supply branch may thus be arranged to elevate liquid coolant to the respective electrical component.

The at least one deaeration line may provide a connection between each high  
30 point of the supply branches and one single junction point of the cooling

circuit. Alternatively, the deaeration line may provide several connections between a high point of several separate supply branches and several separate junction points. Thus, the liquid cooling system may comprise several parallel deaeration lines.

- 5 The cooling circuit may comprises an inlet flow line and a return flow line wherein the at least one supply branch provides a connection between the inlet flow line and the return flow line.

The liquid cooling system may comprise a pump for circulating the liquid coolant in the cooling circuit. The pump may be arranged to discharge high  
10 pressure liquid coolant to the inlet flow line.

Furthermore, the liquid cooling system may comprise a heat exchanger to cool the liquid coolant after circulation through the cooling circuit. The heat exchanger may be provided on the return flow line downstream of the last of the at least one supply branch.

- 15 In case the cooling circuit comprises an inlet flow line and a return flow line, the at least one junction point may be provided on the return flow line. In case several supply branches provide connections between the inlet flow line and the return flow line, several junction points may be provided immediately downstream of each supply branch.

- 20 The liquid cooling system may further comprise at least one electrical component to be cooled. The at least one electrical component may be constituted by one or more power modules, such as converters.

The inlet flow line may be located geodetically below the at least one electrical component. The at least one supply branch may thus extend substantially  
25 vertically to provide liquid coolant to cool a respective electrical component.

The at least one high point may be a local high point. Alternatively, or in addition, the at least one high point may be a geodetically highest point of the cooling circuit.

The liquid cooling system may further comprise a valve for closing the deaeration line. The deaeration line can thereby be closed with the valve when deaeration is not required. For example, a continuous circulation of liquid coolant through the deaeration line may not be necessary at all times.

- 5 Instead, the deaeration may be carried out at commissioning and/or during scheduled maintenance. The liquid cooling system may comprise more than one valve, for example in case several deaeration lines provide connections to several separate junction points. The one or more valves may be manually operable.
- 10 According to a further aspect, there is provided a method of operating a liquid cooling system for cooling at least one electrical component, the method comprising the steps of circulating liquid coolant in a cooling circuit having at least one supply branch for supplying liquid coolant to an electrical component; connecting at least one high point and a junction point of the
- 15 cooling circuit to bypass a part of the cooling circuit; wherein the pressure of the liquid coolant is lower in the junction point than in the high point. The step of connecting at least one high point and a junction point of the cooling circuit may be constituted by the step of connecting at least one high point of the at least one supply branch and a junction point of the cooling circuit.
- 20 The method may further comprise the step of closing or opening a deaeration line connected between the at least one high point and the junction point by means of a valve. The valve may be manually operable.

### **Brief Description of the Drawings**

- Further details, advantages and aspects of the present disclosure will become
- 25 apparent from the following embodiments taken in conjunction with the drawings, wherein:

Fig. 1: schematically represents a liquid cooling system; and

Fig. 2: schematically represents a further liquid cooling system.



## Detailed Description

In the following, a liquid cooling system for cooling at least one electrical component and a method of operating a liquid cooling system for cooling at least one electrical component will be described. The same reference  
5 numerals will be used to denote the same or similar structural features.

Fig. 1 schematically represents a liquid cooling system 10. The liquid cooling system 10 comprises a cooling circuit 12 for cooling a plurality of electrical components 14. In Fig. 1, the electrical components 14 are constituted by four power modules, such as PEBBs (Power Electronic Building Blocks). The  
10 number of power modules is merely an example.

The liquid cooling system 10 comprises a pump 16 for delivering pressurized and cooled liquid coolant to an inlet flow line 18 of the cooling circuit 12. The cooling circuit 12 further comprises four supply branches 20, each for supplying liquid coolant to a respective electrical component 14 to be cooled.

15 A first supply branch 20 (the leftmost supply branch 20 in Fig. 1) branches off from the inlet flow line 18 and elevates to a first electrical component 14 to cool the same and back to a return flow line 22. Similarly, a second and third supply branch 20 branch off from the inlet flow line 18 and elevate to a respective second and third electrical component 14 to be cooled and back to  
20 the return flow line 22. For providing liquid coolant to the last electrical component 14 (here, the fourth electrical component 14), the inlet flow line 18 transitions into the fourth supply branch 20 (i.e. the fourth supply branch 20 does not branch off from the inlet flow line 18) to cool the fourth electrical component 14 and back to the return flow line 22. The supply branches 20 in  
25 Fig. 1 thus have a parallel relationship.

In Fig. 1, each electrical component 14 is positioned geodetically above the inlet flow line 18. Thereby, each supply branch 20 may be said to elevate liquid coolant to the respective electrical component 14.

The path of the supply branches 20 in the respective electrical component 14 is merely schematically illustrated. Each supply branch 20 may guide the cooling liquid in a path layout that provides the best cooling for the respective electrical component 14. For example, each supply branch 20 may be laid in a serpentine shape along one or several surfaces of each electrical component 14 to provide a good cooling of the same.

The liquid cooling system 10 further comprises a deaeration vessel 24 to remove the air and gas entrapped in the liquid coolant in the return flow line 22 and a heat exchanger 26 for cooling the liquid coolant, heated when cooling the electrical components 14, before being circulated again in the cooling circuit 12.

The liquid cooling system 10 further comprises a deaeration line 28. A deaeration conduit 30 associated with each supply branch 20 connect a geodetically high point 32 to the deaeration line 28. In the implementation of Fig. 1, a high point 32 constituting a geodetically highest point of each supply branch 20 is connected to the deaeration line 28. The high points 32 of the supply branches 20 are substantially horizontally aligned and also constitute the vertically highest points of the cooling circuit 12.

The deaeration line 28 is connected to the return flow line 22 at a junction point 34. More specifically, the junction point 34 is positioned downstream of the first supply branch 20 (i.e. the left supply branch 20 in Fig. 1). Thus, the deaeration line 28 functions as a bypass line that bypasses a part of the main flow through the cooling circuit 12. Moreover, the deaeration line 28 provides a connection between the high points 32 of the supply branches 20 and the junction point 34 of the cooling circuit 12.

When the liquid coolant is circulated in the cooling circuit 12 and reaches a high point 32, the pressure in the liquid coolant will decrease downstream of the high point 32. Since the junction point 34 is geodetically below each high point 32 of the respective supply branch 20 in Fig. 1, also the gravity force will contribute to a decreasing liquid coolant pressure downstream of each

high point 32 of the respective supply branch 20. Thus, the pressure is lower in the junction point 34 than in each high point 32 of the supply branches 20.

The liquid cooling system 10 further comprises a valve 36. The valve 36 is arranged on the deaeration line 28 and is moveable between a closed position and an open position (optionally also to any intermediate position) in order to close and open the deaeration line 28 (or restrict the flow in the deaeration line 28). In this implementation, the valve 36 is manually operable.

When the valve 36 adopts the closed position and the pump 16 is running, the entire flow of liquid coolant is circulated in the cooling circuit 12. In this mode of operation, air and gas entrapped in the liquid coolant might accumulate in the high points 32 of the supply branches 20. As a consequence, the cooling provided by the cooling circuit 12 might be deteriorated.

In order to remove the air and gas entrapped in the liquid coolant and accumulated in the high points 32 of the supply branches 20, the valve 36 may be opened. This may be done while the liquid cooling system 10 is operating, i.e. as the liquid coolant circulates in the cooling circuit 12. When the valve 36 adopts the open position, the flow of liquid coolant is divided into a first part circulating in the cooling circuit 12, i.e. from the inlet flow line 18, through the supply branches 20 and to the return flow line 22, and a second part constituting a bypass flow. This second part of the liquid coolant flow is guided from the inlet flow line 18, to a respective supply branch 20, to a high point 32 of the respective supply branch 20, to a deaeration conduit 30 connected to a respective high point 32, to the deaeration line 28, through the valve 36 and to the junction point 34 where the first and second flows of liquid coolant are joined. In the implementation of Fig. 1, the second flow may constitute, for example, approximately 2% of the first flow.

In this manner, any air and gas entrapped at the high points 32 are removed with the second liquid coolant flow. More specifically, liquid coolant containing the air and gas (or containing a high amount of air and gas), i.e.

"low quality" liquid coolant, is transported away from the respective high point 32. The air and gas may then be removed from the liquid coolant by means of the deaeration vessel 24. The liquid coolant purified by the deaeration vessel 24 may then be circulated anew in the liquid cooling  
5 system. Since air and gas is removed from the high points 32, the cooling effect is improved. More specifically, the liquid coolant approaching the high points 32 is not blocked by air and gas (or is blocked to a reduced extent).

The valve 36 may be left open to continue bypassing a partial flow (i.e. the second flow) through the deaeration line 28 during further operation of the  
10 liquid cooling system 10. Alternatively, the valve 36 may be closed again to circulate all liquid coolant in the cooling circuit 12.

As an alternative design, the liquid cooling system 10 may comprise a deaeration line 28 associated with each high point 32. A fourth deaeration line 28 may provide a connection between the fourth high point 32 (i.e. the  
15 rightmost high point 32 in Fig. 1) and a junction point 34 on the return flow line 22 downstream of the fourth supply branch 20 but upstream of the third supply branch 20. A third and second deaeration line 28 associated with the respective third and second high point 32 may provide a connection between the respective third and second high point 32 and a respective junction point  
20 34 on the return flow line 22 downstream of the third and second supply branch 20, respectively, but upstream of the second and first supply branch 20, respectively. A first deaeration line 28 may provide a connection between the first high point 32 and a junction point 34 on the return flow line 22 downstream of the first supply branch 20.

25 Fig. 2 schematically represents a further liquid cooling system 10. Mainly differences with respect to the liquid cooling system 10 of Fig. 1 will be described.

The liquid cooling system 10 of Fig. 2 comprises nine electrical components 14 to be cooled. Also in Fig. 2, the electrical components 14 are constituted by  
30 power modules. A first set of three electrical components 14 are cooled by a

first supply branch 20, a second set of three electrical components 14 are cooled by a second supply branch 20 and a third set of three electrical components 14 are cooled by a third supply branch 20. The supply branches 20 of the cooling circuit 12 have a parallel relationship.

5 Each supply branch 20 comprises three sub-branches 38 where one sub-branch 38 is associated with each electrical component 14. Each sub-branch 38 is connected to a point on the supply branch 20 upstream of the high point 32 and to a point on the supply branch 20 downstream of the high point 32. For each supply branch 20, the sub-branches 38 thus have a parallel  
10 relationship. The high points 32 of the supply branches 20 are connected to the return flow line 22 in the same manner as in Fig. 1.

In Fig. 2, each sub-branch 38 diverts in a substantially horizontal direction from a portion of the supply branch 20 upstream of the high point 32 and to a respective electrical component 14 to be cooled. Any air or gas in the liquid  
15 coolant in the inlet flow line 18 is therefore less likely to be circulated in a sub-branch 38 to an electrical component 14. Instead, any air or gas in the liquid coolant in the inlet flow line 18 is more prone to rise (due to its lower weight) directly to a respective high point 32 without being introduced in a sub-branch 38. Also in this manner, the cooling effect of the liquid cooling  
20 system 10 is improved.

While the present disclosure has been described with reference to exemplary embodiments, it will be appreciated that the present invention is not limited to what has been described above. For example, it will be appreciated that the dimensions of the parts may be varied as needed. Accordingly, it is intended  
25 that the present invention may be limited only by the scope of the claims appended hereto.

**CLAIMS**

1. Liquid cooling system (10) for cooling at least one electrical component (14), the liquid cooling system (10) comprising:
  - a cooling circuit (12) having at least one supply branch (20) for  
5 supplying liquid coolant to an electrical component (14); and
  - at least one deaeration line (28) to provide a connection between a high point (32) and a junction point (34) of the cooling circuit (12) to bypass a part of the cooling circuit (12);wherein the pressure of the liquid coolant is lower in the junction point (34) than in the high point (32) during circulation of the liquid coolant  
10 in the liquid cooling system (10).
2. The liquid cooling system (10) according to claim 1, wherein the high point (32) is a high point (32) of the at least one supply branch (20).
3. The liquid cooling system (10) according to claim 1 or 2, wherein the  
15 junction point (34) is geodetically below the high point (32).
4. The liquid cooling system (10) according to claim 1 or 2, wherein the junction point (34) is geodetically above the high point (32).
5. The liquid cooling system (10) according to claim 1, wherein the liquid cooling system (10) comprises:
  - a plurality of supply branches (20) for supplying liquid coolant to a  
20 plurality of electrical components (14); and
  - at least one deaeration line (28) to provide a connection between each high point (32) of the supply branches (20) and at least one junction point (34) of the cooling circuit (12);wherein the pressure of the liquid coolant is lower in the at least one  
25 junction point (34) than in the respective high point (32) connected to the junction point (34) by means of the deaeration line (28).
6. The liquid cooling system (10) according to claim 5, wherein the at least one junction point (34) is geodetically below the respective high point

(32) connected to the junction point (34) by means of the deaeration line (28).

7. The liquid cooling system (10) according to claim 5 or 6, wherein the at least one deaeration line (28) provides a connection between each high point (32) of the supply branches (20) and one single junction point (34) of the cooling circuit (12).
8. The liquid cooling system (10) according to any of the preceding claims, wherein the cooling circuit (12) comprises:
- an inlet flow line (18); and
  - a return flow line (22);
- wherein the at least one supply branch (20) provides a connection between the inlet flow line (18) and the return flow line (22).
9. The liquid cooling system (10) according to any of the preceding claims, wherein the cooling circuit (12) comprises:
- an inlet flow line (18); and
  - a return flow line (22);
- wherein the at least one junction point (34) is provided on the return flow line (22).
10. The liquid cooling system (10) according to any of the preceding claims, further comprising at least one electrical component (14) to be cooled.
11. The liquid cooling system (10) according to claims 8 or 9 and 10, wherein the inlet flow line (18) is located geodetically below the at least one electrical component (14).
12. The liquid cooling system (10) according to any of the preceding claims, wherein the at least one high point (32) is a local high point.
13. The liquid cooling system (10) according to any of the preceding claims, wherein the at least one high point (32) is a geodetically highest point of the cooling circuit (12).

14. The liquid cooling system (10) according to any of the preceding claims, further comprising a valve (36) for closing the deaeration line (28).
15. Method of operating a liquid cooling system (10) for cooling at least one electrical component (14), the method comprising the steps of:
- 5 - circulating liquid coolant in a cooling circuit (12) having at least one supply branch (20) for supplying liquid coolant to an electrical component (14); and
- connecting at least one high point (32) and a junction point (34) of the cooling circuit (12) to bypass a part of the cooling circuit (12);
- 10 wherein the pressure of the liquid coolant is lower in the junction point (34) than in the high point (32).



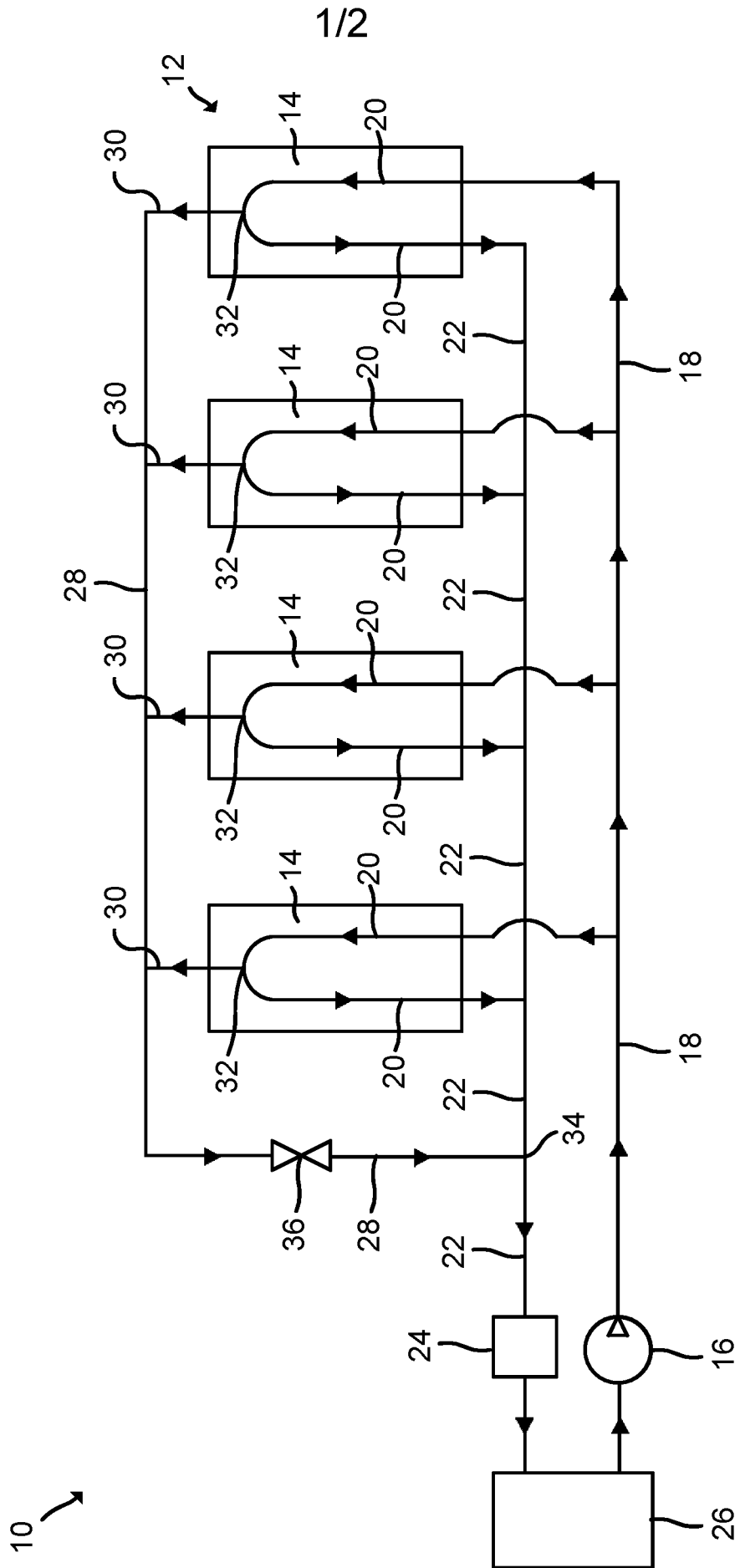


Fig. 1

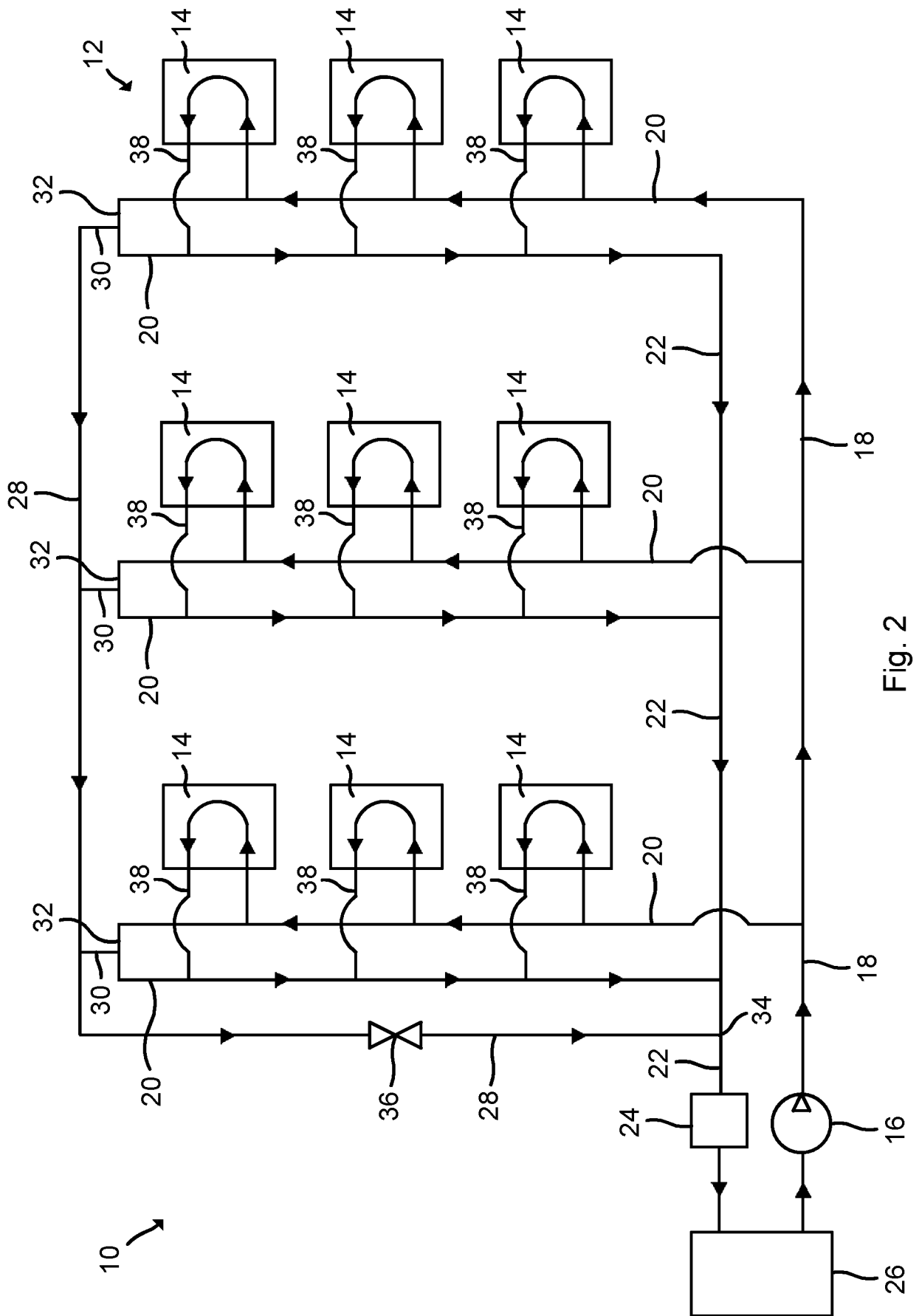


Fig. 2

INTERNATIONAL SEARCH REPORT

International application No  
PCT/EP2016/062391

A. CLASSIFICATION OF SUBJECT MATTER  
INV. H05K7/20  
ADD.  
According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED  
Minimum documentation searched (classification system followed by classification symbols)  
H05K

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)  
EPO-Internal, WPI Data

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	EP 1 637 020 A1 (RITTAL GMBH & CO KG [DE]) 22 March 2006 (2006-03-22) column 0008 - column 0014; claims 1,10; figure 1	1-15
X A	----- US 4 047 561 A (JASTER HEINZ ET AL) 13 September 1977 (1977-09-13) column 1 - column 6; claim 1; figure 1	1,3, 8-10,15 2,4-7, 11-14
A	----- EP 2 790 480 A2 (VACON OYJ [FI]) 15 October 2014 (2014-10-15) the whole document -----	1-15

Further documents are listed in the continuation of Box C.

See patent family annex.

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Date of the actual completion of the international search  13 October 2016	Date of mailing of the international search report  21/10/2016
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Name and mailing address of the ISA/ European Patent Office, P.B. 5818 Patentlaan 2 NL - 2280 HV Rijswijk Tel. (+31-70) 340-2040, Fax: (+31-70) 340-3016	Authorized officer  Seifert, Frank
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# INTERNATIONAL SEARCH REPORT

Information on patent family members

International application No PCT/EP2016/062391
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Patent document cited in search report	Publication date	Patent family member(s)	Publication date
EP 1637020	A1	22-03-2006	CN 1717967 A 04-01-2006
			DE 10326803 A1 13-01-2005
			EP 1637020 A1 22-03-2006
			JP 4201814 B2 24-12-2008
			JP 2006527489 A 30-11-2006
			US 2007165375 A1 19-07-2007
			WO 2004112452 A1 23-12-2004
-----			
US 4047561	A	13-09-1977	NONE
-----			
EP 2790480	A2	15-10-2014	EP 2790480 A2 15-10-2014
			FI 10540 U1 11-07-2014
			US 2014305611 A1 16-10-2014
-----			